- Buffer Version of 'ALS10A
- Package Options include Plastic Small Outline DIPs and Ceramic Chip Carriers in Addition to the Standard 300-mil Plastic and Ceramic DIPs.
- Dependable Texas Instruments Quality and Reliability

description

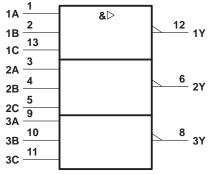
These devices contain three independent 3-input NAND buffers. They perform the Boolean functions $Y = \overline{A} \cdot \overline{B} \cdot \overline{C}$ or $Y = \overline{A} + \overline{B} + \overline{C}$ in positive logic.

The SN54ALS1010A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS1010A is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

	NPUT	OUTPUT				
Α	В	С	Υ			
Н	Н	Н	L			
L	Χ	Χ	Н			
Х	L	Χ	Н			
Х	Χ	L	Н			

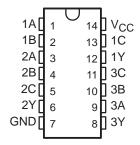
logic symbol †



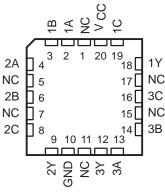
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, and N packages.

SN54ALS1010A . . . J PACKAGE SN74ALS1010A . . . D OR N PACKAGE (TOP VIEW)

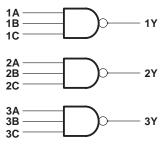


SN54ALS1010A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram (positive logic)



1

SDAS075A - D2661, APRIL 1982 - REVISED MAY 1986

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

SN74ALS1010A 0°C to 70°C

Storage temperature range –65°C to 150°C

recommended operating conditions

		SN54ALS1010A			SN7	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
IOH	High-level output current			-1			-2.6	mA
loL	Low-level output current			12			24	mA
T _A	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54	SN54ALS1010A			SN74ALS1010A			
			MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT	
VIK	V _{CC} = 4.5 V,	I _I = -18 mA			-1.5			-1.5	V	
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2			V _{CC} -2				
Voн	V _{CC} = 4.5 V,	I _{OH} = -1 mA	2.4	3.3					V	
	V _{CC} = 4.5 V,	$I_{OH} = -2.6 \text{ mA}$				2.4	3.3			
VOL	V _{CC} = 4.5 V,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	V	
	V _{CC} = 4.5 V,	I _{OL} = 24 mA					0.35	0.5	V	
Ι _Ι	$V_{CC} = 5.5 \text{ V},$	V _I = 7 V			0.1			0.1	mA	
lН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ	
Ι _Ι L	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1		-	-0.1	mA	
IO [‡]	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30	•	-112	mA	
ICCH	V _{CC} = 5.5 V,	V _I = 0		0.65	1.2		0.65	1.2	mA	
ICCL	V _{CC} = 5.5 V,	V _I = 4.5 V		3.6	5.8		3.6	5.8	mA	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5 \text{ V},$ $C_L = 50 \text{ pF},$ $R_L = 500 \Omega,$ $T_A = 25^{\circ}C$ 'ALS1010A TYP	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V,}$ $C_{L} = 50 \text{ pF,}$ $R_{L} = 500 \Omega,$ $T_{A} = \text{MIN to MAX}$ $SN54ALS1010A SN74ALS1010A$ $MIN MAX MIN MAX$			UNIT	
tPLH	A or B	V	5	2	12	2	8	ns
tPHL	AUIB	1	5	2	12	2	8	115

NOTE 1: Load circuit and voltage waveforms are shown in Section 1.



[‡] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1998, Texas Instruments Incorporated